

# **LOCTITE ABLESTIK 2300-S**

January 2016

#### PRODUCT DESCRIPTION

LOCTITE ABLESTIK 2300-S provides the following product characteristics:

Technology	Ероху
Appearance	Gray
Filler Type	Silver
Product Benefits	<ul> <li>Fast cure</li> <li>Low bleed</li> <li>Low stress</li> <li>Process ease</li> <li>Electrically conductive</li> <li>High hot/wet adhesion</li> <li>Ultra-low moisture absorption</li> <li>Excellent dispensing characteristics</li> <li>260°C reflow capability for Pb-free applications</li> </ul>
Cure	Heat cure
Application	Die attach
pH	3.7
Typical Package Application	PBGA and Array BGA

LOCTITE ABLESTIK 2300-S die attach adhesive has been formulated for use in high throughput die attach applications. It is suitable for die sizes up to 12.7 x 12.7 mm. This material is a high viscosity version of LOCTITE ABLESTIK 2300 adhesive adhesive. This material was originally released as Experimental product RP-596-14.

### TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	5.5
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	12,000
Work Life @ 25°C, hours	24
Shelf Life @ -40°C (from date of manufacture), days	365

# TYPICAL CURING PERFORMANCE

#### **Cure Schedule**

30 minute ramp to 175°C + 15 minutes @ 175°C

#### Weight Loss on Cure

10 x 10 mm Si die on glass slide, % 0.7

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

# TYPICAL PROPERTIES OF CURED MATERIAL Physical Properties

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Thermal Conductivity, W/(m-K)	1.2
Moisture Absorption @ Saturation, wt.% @ 85°C/85°RH	0.22

Glass Transition Temperature (Tg) by TMA, ° TMA penetration mode TMA expansion mode	C:	5 -18.9
Coefficient of Thermal Expansion : Below Tg, ppm/°C Above Tg, ppm/°C		56 116
Extractable Ionic Content, @ 100°C ppm: Chloride (CI-) Sodium (Na+) Potassium (K+)		<10 <10 <10
Tensile Modulus, DMTA:		
@ -65 °C	N/mm² (psi)	
@ 25 °C	N/mm² (psi)	2,450 (355,000)
@ 150 °C	N/mm² (psi)	410 (59,310)
@ 250 °C	N/mm²	495 (71.800)

### **Electrical Properties**

Volume Resistivity, ohms-cm	0.05
Bond Joint Resistance, ohms/0.5 sq inch	0.001

# TYPICAL PERFORMANCE OF CURED MATERIAL

#### Miscellaneous

Die Shear Strength

2 X 2 mm Si die, kg-f/die,

Die on Substrate:	@25°C
PBGA	12

### Die Shear Strength vs Temperature

3 X 3 mm Si die, ka-f/die,

Die on Substrate:	@200°C	@250°C
PBGA	6.1	4.6

# Chip Warpage vs Chip Size

0.38 mm thick Si die on PBGA, µm

Die Size:	@25°C
12.7 x 12.7	29

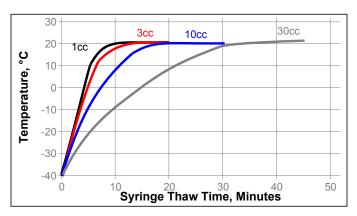
#### **GENERAL INFORMATION**

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).



#### THAWING:

- 1. Allow container to reach room temperature before use.
- After removing from the freezer, set the syringes to stand vertically while thawing.
- Refer to the Syringe Thaw time chart for the thaw time recommendation.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to -40°C, the adhesive should not be re-frozen



#### **DIRECTIONS FOR USE**

- Thawed adhesive should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- Adhesive must be completely used within the products recommended work life.
- Silver-resin separation may occur if the adhesive is left out at room temperature, beyond the recommended work life.
- Apply enough adhesive to achieve a 25 to 50 µm wet bondline thickness, dispensed with approximately 25 to 50 % filleting on all sides of the die.
- Alternate dispense amounts may be used depending on the application requirements.
- Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

#### Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

#### Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches  $N \times 0.225 = Ib$   $N/mm \times 5.71 = Ib/in$   $psi \times 145 = N/mm^2$   $MPa = N/mm^2$   $N \cdot m \times 8.851 = Ib \cdot in$   $N \cdot m \times 0.738 = Ib \cdot ft$   $N \cdot m \times 0.142 = oz \cdot in$  $mPa \cdot s = cP$ 

#### Disclaimer

#### Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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